

LOCTITE 3549

January 2016

PRODUCT DESCRIPTION

LOCTITE 3549 provides the following product characteristics:

Technology	Epoxy
Appearance	Black
Components	One-component
Product Benefits	• Reworkable • Fast flow • Low temperature cure • High adhesion to flexible and rigid substrates • Excellent protection for solder joints against induced stresses
Cure	Heat Cure
Application	Underfill
Typical Assembly Applications	BGA and CSP Devices

LOCTITE 3549 reworkable epoxy underfill is designed to provide protection for solder joints against induced stress, increasing both drop test and temperature cycle performance of the device.

TYPICAL PROPERTIES OF UNCURED MATERIAL

Density, @ 25 °C, g/cm ³	1.3
Viscosity @ 25 °C, mPa·s (cP):	
Haake PK100 @ 36 S ⁻¹	2,350
Cone & Plate, Spindle 52, speed 50 rpm	2,100
Filler Content, %	18
Pot Life @ 25 °C (time to double viscosity), days	14
Shelf Life @ -25 to -15°C, days	365
Flash Point - See SDS	

TYPICAL CURING PERFORMANCE

Recommended Cure Schedule

5 minutes @ 120 °C
3 minutes @ 130 °C
1 minute @ 150 °C reflow

Optional Reflow Cure (for Drop Test Reliability)

2 minutes @ 130°C

Substrate Temperature

Up to 70°C

Differential Scanning Calorimetry

Exotherm onset, °C	100 to 115
--------------------	------------

Peak Exotherm Temperature

Peak Temperature, °C	105 to 115
----------------------	------------

The above cure profile is a guideline recommendation. Cure conditions (time and temperature) may vary based on customers' experience and their application requirements, as well as customer curing equipment, oven loading and actual oven temperatures.

TYPICAL PROPERTIES OF CURED MATERIAL

Sample cured , 1 hour @ 125°C

Physical Properties

Coefficient of Thermal Expansion ISO 11359-2, K ⁻¹ :		
Below Tg		55
Above Tg		177
Glass Transition Temperature (Tg) by TMA, °C:		
TMA from -50 to 300°C @ 10°C/minute		38
Storage Modulus:		
DMA from 22 to 300°C @ 10°C/minute	N/mm ² (psi)	2,000 (290,075)

Electrical Properties

Volume Resistivity, IEC 60093, Ω·cm	81×10 ¹⁵
Surface Resistivity, IEC 60093, Ω	0.2×10 ¹⁵

GENERAL INFORMATION

For safe handling information on this product, consult the Material Safety Data Sheet, (MSDS).

This product is not recommended for use in pure oxygen and/or oxygen rich systems and should not be selected as a sealant for chlorine or other strong oxidizing materials.

Not for product specifications

The technical data contained herein are intended as reference only. Please contact your local quality department for assistance and recommendations on specifications for this product.

Removal Procedure

1. Heat the underfill to approximately 220 °C using a hot air nozzle on standard BGA rework equipment.
2. Twist and remove the component.
3. Use a tacky flux together with a vacuum nozzle attachment to remove residue.

Storage

Store product in the unopened container in a dry location. Storage information may be indicated on the product container labeling.

Optimal Storage : -25 to -15 °C

Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Technical Service Center or Customer Service Representative.

Conversions $(^{\circ}\text{C} \times 1.8) + 32 = ^{\circ}\text{F}$ $\text{kV/mm} \times 25.4 = \text{V/mil}$ $\text{mm} / 25.4 = \text{inches}$ $\text{N} \times 0.225 = \text{lb}$ $\text{N/mm} \times 5.71 = \text{lb/in}$ $\text{psi} \times 145 = \text{N/mm}^2$ $\text{MPa} = \text{N/mm}^2$ $\text{N}\cdot\text{m} \times 8.851 = \text{lb}\cdot\text{in}$ $\text{N}\cdot\text{m} \times 0.738 = \text{lb}\cdot\text{ft}$ $\text{N}\cdot\text{mm} \times 0.142 = \text{oz}\cdot\text{in}$ $\text{mPa}\cdot\text{s} = \text{cP}$ **Disclaimer****Note:**

The information provided in this Technical Data Sheet (TDS) including the recommendations for use and application of the product are based on our knowledge and experience of the product as at the date of this TDS. The product can have a variety of different applications as well as differing application and working conditions in your environment that are beyond our control. Henkel is, therefore, not liable for the suitability of our product for the production processes and conditions in respect of which you use them, as well as the intended applications and results. We strongly recommend that you carry out your own prior trials to confirm such suitability of our product.

Any liability in respect of the information in the Technical Data Sheet or any other written or oral recommendation(s) regarding the concerned product is excluded, except if otherwise explicitly agreed and except in relation to death or personal injury caused by our negligence and any liability under any applicable mandatory product liability law.

In case products are delivered by Henkel Belgium NV, Henkel Electronic Materials NV, Henkel Nederland BV, Henkel Technologies France SAS and Henkel France SA please additionally note the following:

In case Henkel would be nevertheless held liable, on whatever legal ground, Henkel's liability will in no event exceed the amount of the concerned delivery.

In case products are delivered by Henkel Colombiana, S.A.S. the following disclaimer is applicable:

The information provided in this Technical Data Sheet (TDS) including the recommendations for use and application of the product are based on our knowledge and experience of the product as at the date of this TDS. Henkel is, therefore, not liable for the suitability of our product for the production processes and conditions in respect of which you use them, as well as the intended applications and results. We strongly recommend that you carry out your own prior trials to confirm such suitability of our product.

Any liability in respect of the information in the Technical Data Sheet or any other written or oral recommendation(s) regarding the concerned product is excluded, except if otherwise explicitly agreed and except in relation to death or personal injury caused by our negligence and any liability under any applicable mandatory product liability law.

In case products are delivered by Henkel Corporation, Resin Technology Group, Inc., or Henkel Canada Corporation, the following disclaimer is applicable:

The data contained herein are furnished for information only and are believed to be reliable. We cannot assume responsibility for the results obtained by others over whose methods we have no control. It is the user's responsibility to determine suitability for the user's purpose of any production methods mentioned herein and to adopt such precautions as may be advisable for the protection of property and of persons against any hazards that may be involved in the handling and use thereof. In light of the foregoing, **Henkel Corporation specifically disclaims all warranties expressed or implied, including warranties of merchantability or fitness for a particular purpose, arising from sale or use of Henkel Corporation's products. Henkel Corporation specifically disclaims any liability for consequential or incidental damages of any kind, including lost profits.** The discussion herein of various processes or compositions is not to be interpreted as representation that they are free from domination of patents owned by others or as a license under any Henkel Corporation patents that may cover such processes or compositions. We recommend that each prospective user test his proposed application before repetitive use, using this data as a guide. This product may be covered by one or more United States or foreign patents or patent applications.

Trademark usage

Except as otherwise noted, all trademarks in this document are trademarks of Henkel Corporation in the U.S. and elsewhere. ® denotes a trademark registered in the U.S. Patent and Trademark Office.

Reference 1

Americas
+1.888.943.6535

Europe
+32.1457.5611

Asia
+86.21.3898.4800

For the most direct access to local sales and technical support visit: www.henkel.com/electronics